



Product Change Notification

Change Notification #: 117162 - 00
Change Title: The Intel® Wireless-AC3165 1216 SKUs:
3165.D2WG; 3165.D2WG.S;
3165.D2WG18V
PCN 117162-00,
Label,
Add Argentina ID on labels
Date of Publication: September 19, 2019

Key Characteristics of the Change:
Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	October 4, 2019
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Description of Change to the Customer:

The Intel® Wireless-AC3165 1216 SKUs listed in the products affected table below will undergo the following changes:

- Labels will have the Argentina ID C-16005 added. Refer to label images below
- The Intel Tracking revision will be changed on the following products

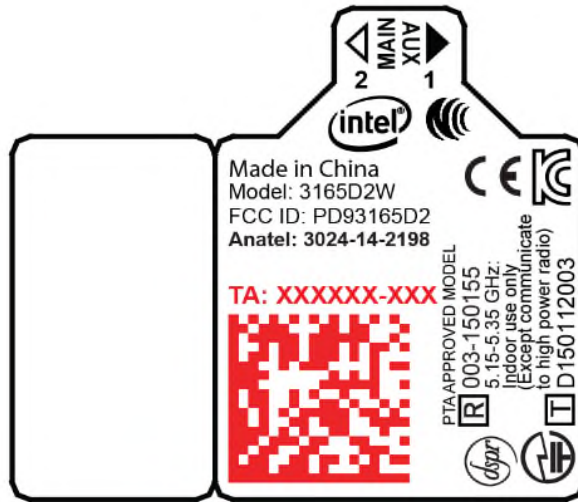
Product Code	Before	After
3165.D2WG	0F	0G

3165.D2WG MBB/Disti Label (Before)

3165.D2WG VERSION #: H93202-008 MM#: XXXXXX QTY: 1000 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVMR55	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W) PKG ID (S) VVVVMMMMDDDD#PPPPPP190 HP PIN: 843530-001 REV: 0F D PIN: P#PPPP REV AX# L PIN: XXXXXXXXXXXX EC: XXXXXXXX	CE, FCC, RoHS, REACH, CCAH15LP13207P, CMIIT ID: 2015AJ2486 (M), MSP-CRM-INT-72602W
		Vendor ID Loc ID VVVVLLLLL M# M#MM# L PIN: XXXXXXXXXXXX EC: XXXXXXXX	C-16884, C-16892, C-16885

3164.D2WG MBB/Disti Label (After)

3165.D2WG VERSION #: H93202-009 MM#: XXXXXX QTY: 1000 MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX PACK DATE: DD MMM YY PACKED BY: XXXXXX BATCH #: CCVVMR55	1 88334 00140 2 9 310779 300005	Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W) PKG ID (S) VVVVMMMMDDDD#PPPPPP190 HP PIN: 843530-001 REV: 0G D PIN: P#PPPP REV AX# L PIN: XXXXXXXXXXXX EC: XXXXXXXX	CE, FCC, RoHS, REACH, CCAH15LP13207P, CMIIT ID: 2015AJ2486 (M), MSP-CRM-INT-72602W
		Vendor ID Loc ID VVVVLLLLL M# M#MM# L PIN: XXXXXXXXXXXX EC: XXXXXXXX	C-16884, C-16892, C-16885



intel® 3165.D2WXXXXX QTY: XXXX VERSION #: XXXXXX-XXX MM #: XXXXXX	(Pb) (LH) 2LI (e1)
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Notes: TA is equivalent to TA number. Please refer table below for exact TA number.

3165.D2WG.S MBB/Disti Label (Before)

<p>3165.D2WG.S</p> <p>VERSION #: H93203-004</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX</p>	<p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>	<p>QTY: 1000</p> <p>88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (S) VVVVMMMMDD08###PPPPPP100</p> <p>T P/N: GDM48000218</p> <p>D P/N: P P P P P P REV AX X HP P/N: XXXXXX-XXX REV: XX</p> <p>PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc ID Mfg ID L P/N: XXXXXXXXXXXX</p> <p>XXXXXXXXXX XXXXXXXX EC: XXXXXXXX</p>	<p>CE, FCC, RoHS, REACH, etc.</p> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1640 USA www.intel.com</p> <p>CMIT ID: 2015A3496 (M)</p> <p>MSP-CRM-INT-72052W</p>
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3165.D2WG.S MBB/Disti Label (After)

<p>3165.D2WG.S</p> <p>VERSION #: H93203-005</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXXXX</p>	<p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>	<p>QTY: 1000</p> <p>88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (S) VVVVMMMMDD08###PPPPPP100</p> <p>T P/N: GDM48000218</p> <p>D P/N: P P P P P P REV AX X HP P/N: XXXXXX-XXX REV: XX</p> <p>PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc ID Mfg ID L P/N: XXXXXXXXXXXX</p> <p>XXXXXXXXXX XXXXXXXX EC: XXXXXXXX</p>	<p>CE, FCC, RoHS, REACH, etc.</p> <p>Intel Corporation 2200 Mission College Blvd Santa Clara, CA 95054-1640 USA www.intel.com</p> <p>CMIT ID: 2015A3496 (M)</p> <p>MSP-CRM-INT-72052W</p>
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intel

Made in China
Model: 3165D2W
FCC ID: PD93165D2
Anatel: 3024-14-2198

TA: XXXXXX-XXX

PTA APPROVED MODEL
R 003-150155
5.15-5.35 GHz:
Indoor use only
(Except communicate
to high power radio)

D 150 112003

CE, FCC, RoHS, REACH, etc.

<p>intel 3165.D2WXXXXX</p> <p>VERSION #: XXXXXX-XXX</p> <p>MM #: XXXXXX</p>	<p>QTY: XXXX</p> <p>Pb, LH, e1, 2LI</p>
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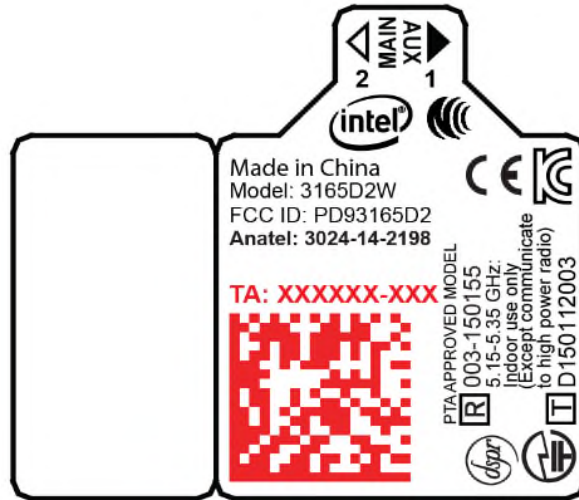
Notes: TA is equivalent to TA number. Please refer table below for exact TA number.

3165.D2WG18V MBB/Disti Label (Before)

<p>3165.D2WG18V</p> <p>VERSION #: H93207-004</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p>	<p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>	<p>QTY: 1000</p> <p>1 88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) VVVVMMMMDDDD#PPPPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: P P P P P P REV: A X X</p> <p>HP P/N: XXXXXX-XXX REV: X X</p> <p>PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc ID Mfg Id L P/N: XXXXXXXXXXXX VVVVVVLLLL M#M#M#M# EC: XXXXXXXX</p>	<p>CE, FCC, CNG, Intel Corporation</p> <p>2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CCAH15LP13207P CMIT ID: 2015AJ2465 (M)</p> <p>CRC ID: C-16844 CRC ID: C-16892 CRC ID: C-16955</p> <p>MSP-CRM-INT-726522W</p>
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3165.D2WG18V MBB/Disti Label (After)

<p>3165.D2WG18V</p> <p>VERSION #: H93207-005</p> <p>MADE IN CHINA WITH PARTIAL FOREIGN CONTENT CARTON #: VVXXXXXXXX</p>	<p>MM#: XXXXXX</p> <p>PACK DATE: DD MMM YY PACKED BY: XXXXXX</p> <p>BATCH #: CCVVYMDRSS</p>	<p>QTY: 1000</p> <p>1 88334 00140 2</p> <p>9 310779 300005</p>	<p>Intel® Dual Band Wireless-AC 3165 (Model: 3165D2W)</p> <p>PKG ID (3S) VVVVMMMMDDDD#PPPPPP100</p> <p>T P/N: GTTTTTTTTT</p> <p>D P/N: P P P P P P REV: A X X</p> <p>HP P/N: XXXXXX-XXX REV: X X</p> <p>PACKAGE WEIGHT: X.X LBS</p> <p>Vendor ID Loc Id Mfg Id L P/N: XXXXXXXXXXXX VVVVVVLLLL M#M#M#M# EC: XXXXXXXX</p>	<p>CE, FCC, CNG, Intel Corporation</p> <p>2200 Mission College Blvd Santa Clara, CA 95054-1549 USA www.intel.com</p> <p>CCAH15LP13207P CMIT ID: 2015AJ2465 (M)</p> <p>CRC ID: C-16844 CRC ID: C-16892 CRC ID: C-16955</p> <p>MSP-CRM-INT-726522W</p>
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<p>intel® 3165.D2WXXXXX</p> <p>VERSION #: XXXXXX-XXX</p> <p>MM #: XXXXXX</p>	<p>QTY: XXXX</p> <p>LH Pb 2LI e1</p>
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Notes: TA is equivalent to TA number. Please refer table below for exact TA number.

Customer Impact of Change and Recommended Action:

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

*Other names and brands may be claimed as the property of others.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
3165.D2WG	944381	H83890-009	H83890-010
3165.D2WG18V	944382	H83892-008	H83892-009
3165.D2WG.S	944397	H85667-008	H85667-009

PCN Revision History:

Date of Revision:

September 19, 2019

Revision Number:

00

Reason:

Originally Published PCN



Product Change Notification

117162 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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